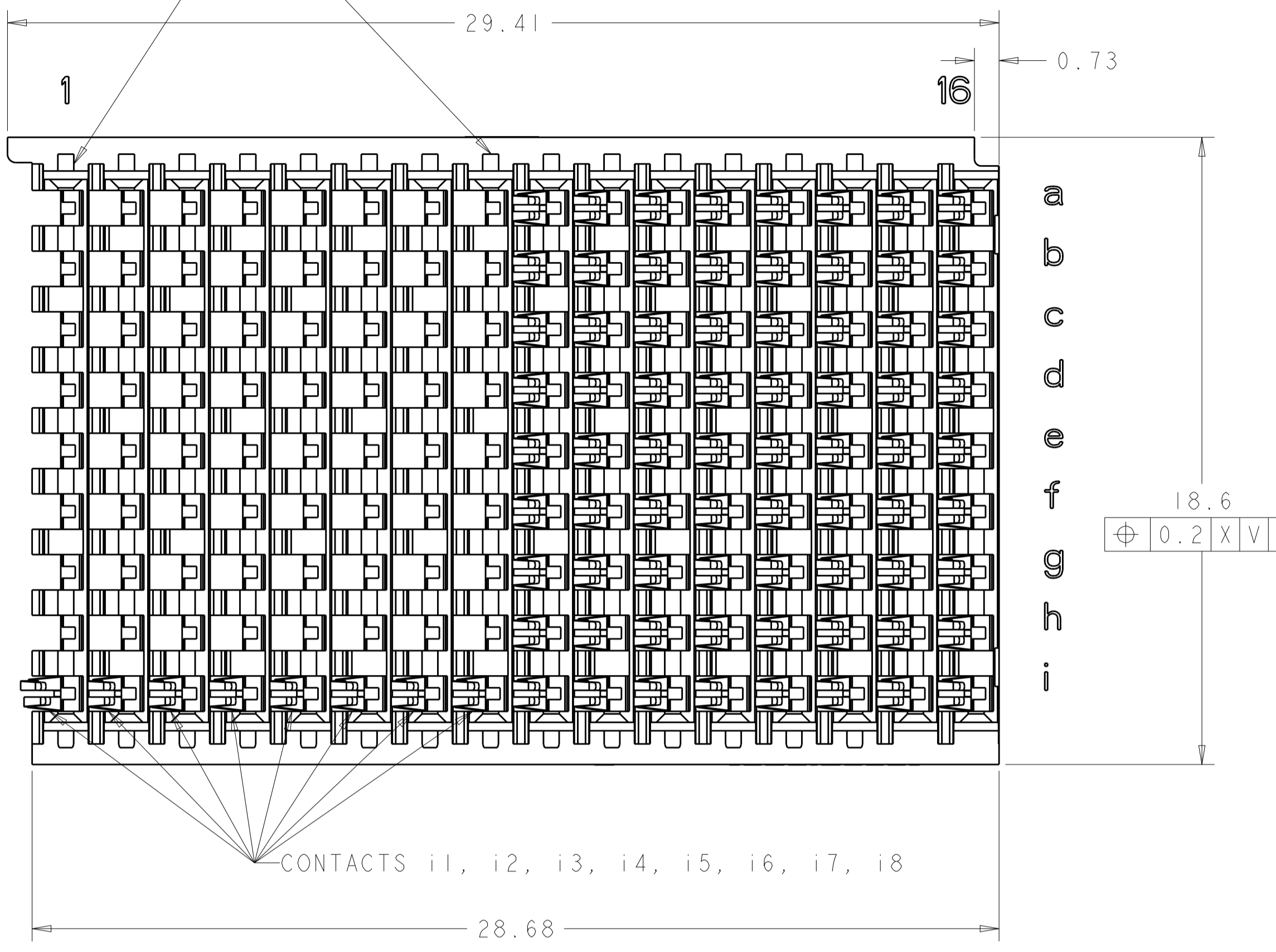
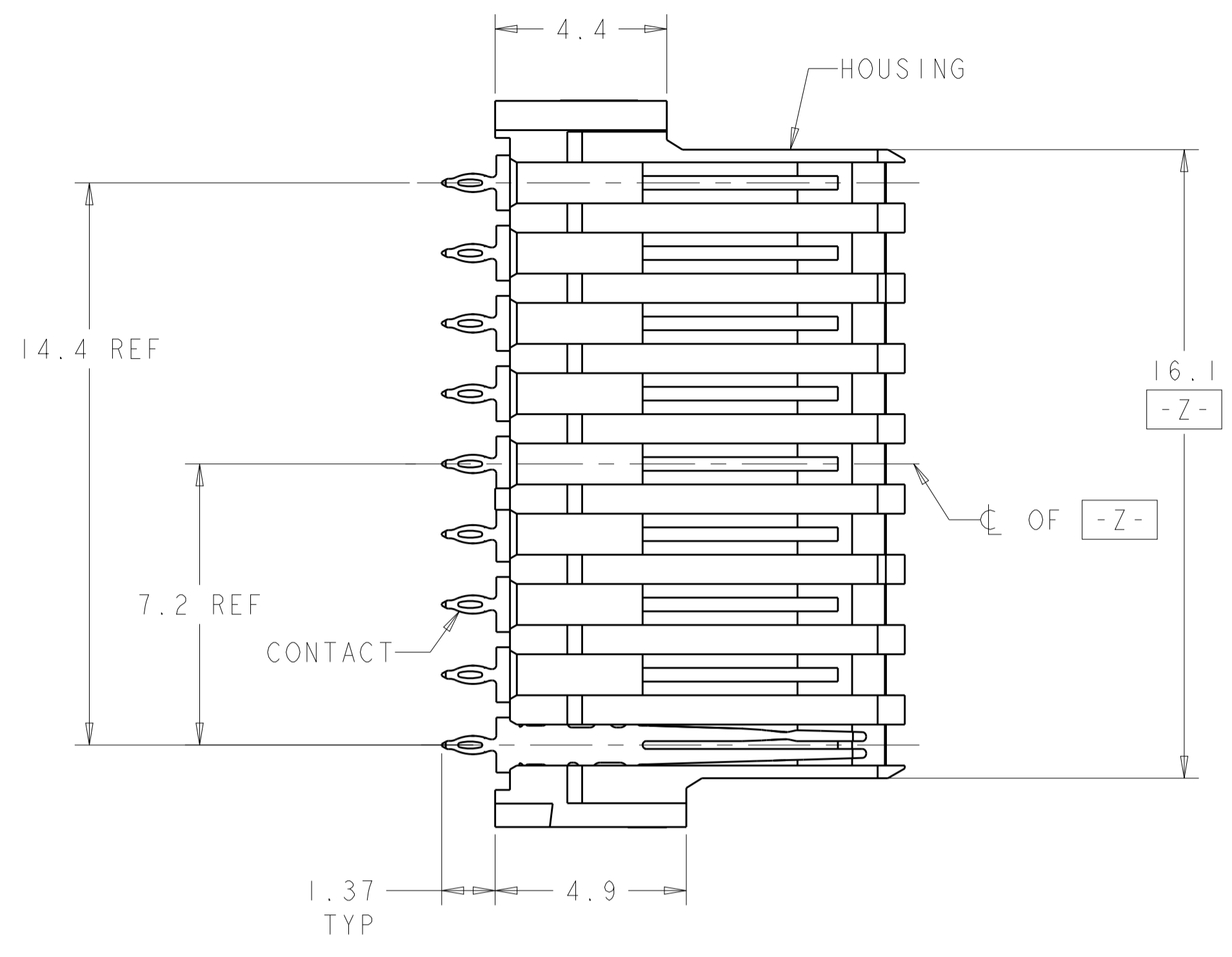
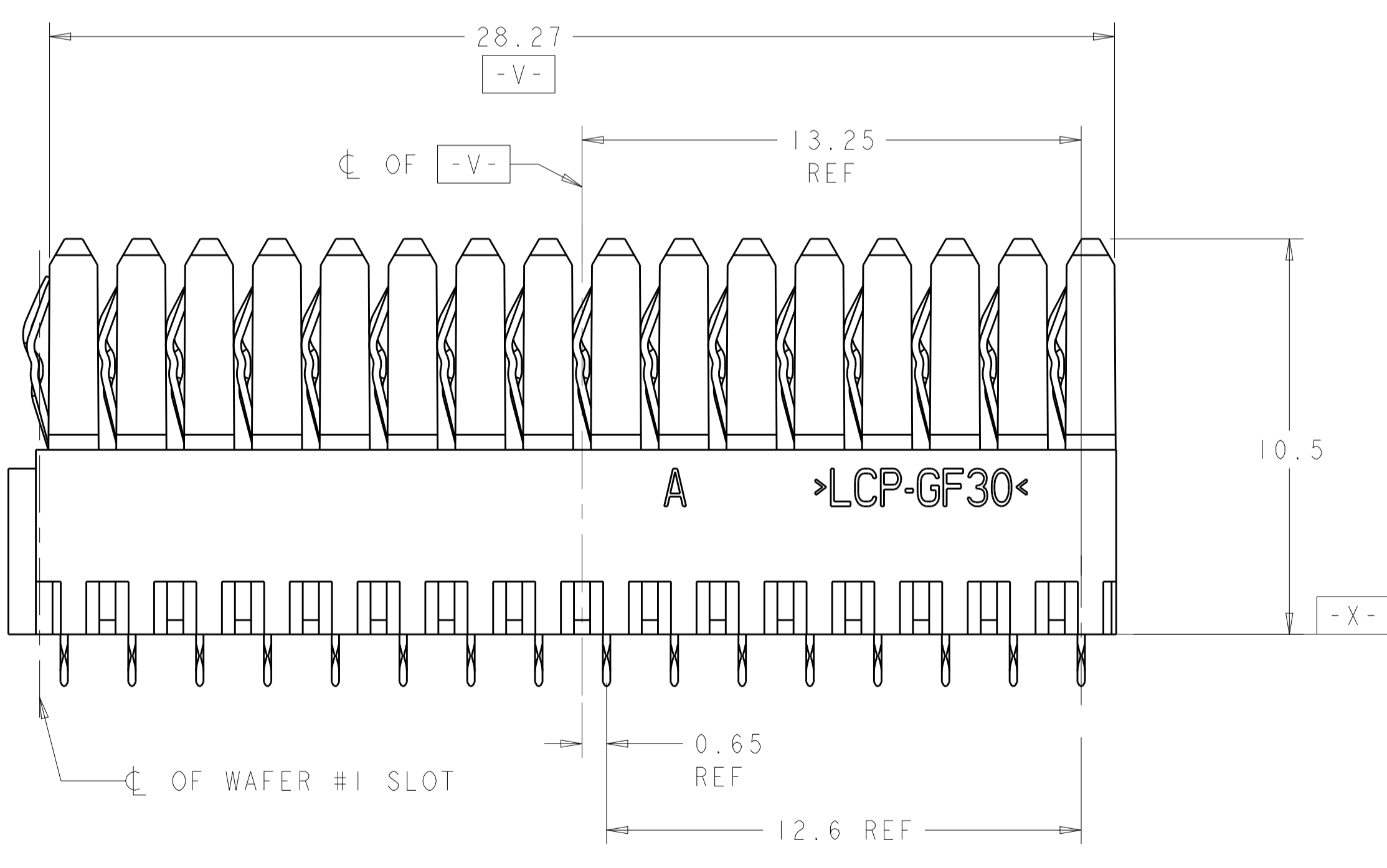
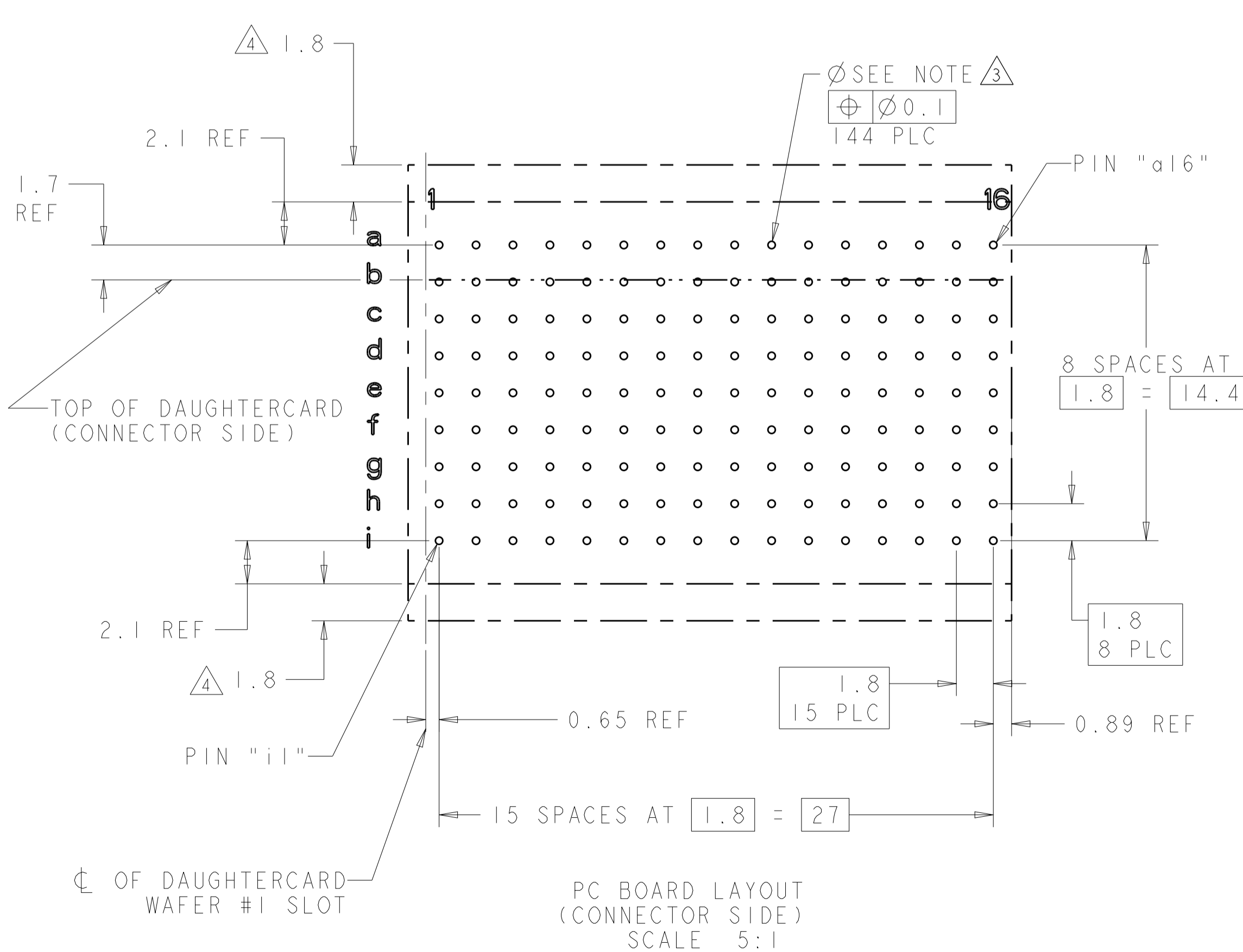


REVISIONS				
P.	LTN.	DESCRIPTION	DATE	APVD.
A		RELEASED PER ECO-19-001811	05FEB2019	DCB AT

COLUMNS 1 THRU 8  
CONTACTS NOT LOADED  
EXCEPT i1, i2, i3, i4, i5, i6, i7, i8



- 1 HOUSING: LCP, UL94V0, COLOR: BLACK.  
CONTACT: PHOSPHOR BRONZE.
- 2 FINISH: 1.27µm GOLD IN CONTACT AREA 1.27µm MIN. TIN-LEAD ON PCB TAIL OVER 2.54µm MIN. NICKEL OVER ALL.
- 3 PLATED THRU HOLE SPECIFICATION:  
-DRILLED HOLE: Ø0.45±0.02  
-0.025-0.050 THICK COPPER PLATING (MAX HARDNESS 150 KNOOP)  
FINISH OPTIONS:  
-0.0038-0.0124 HOT AIR SOLDER LEVELING (HASL) TIN-LEAD (SnPb)  
-0.0005-0.004 IMMERSION TIN (Sn)  
-0.0002-0.0005 ORGANIC SOLDERABILITY PRESERVATIVE (OSP)  
-0.0001-0.0005 IMMERSION SILVER (Ag)  
-0.0001-0.0005 IMMERSION GOLD OVER  
0.00127-0.0076 NICKEL (ENIG)  
FINISH HOLE DIAMETER AFTER PLATING = Ø0.36 REF
- 4 ADDITIONAL CONNECTOR-SIDE KEYPOT AREA REQUIRED IF CONNECTOR-SIDE EXTRACTION TOOL IS TO BE USED.
- 5 FINISH: 1.27µm MIN GOLD IN CONTACT AREA, 0.50µm MIN TIN ON PCB TAIL OVER 2.54µm MIN. NICKEL OVER ALL.



5	2302793-2
2	2302793-1
PLATING	PART NO

THIS DRAWING IS A CONTROLLED DOCUMENT.

OWN: R. MILLER 11 JUL 2017  
CHK: A. TSANG 11 JUL 2017  
APVD: -

DIMENSIONS: mm

TOLERANCES UNLESS OTHERWISE SPECIFIED:

0 PLC	±
1 PLC	±0.5
2 PLC	±0.13
3 PLC	±
4 PLC	±
ANGLES	±1°

MATERIAL: SEE TABLE

PRODUCT SPEC: 108-2072-3  
APPLICATION SPEC: 114-163004

SIZE: 114-163004  
WEIGHT: 5.35g

RESTRICTED CUSTOMER

NAME: VERTICAL RECEPTACLE ASSEMBLY, CENTER, SELECT LOAD, RTM MULTIGIG RT 3

SCALE: 2:1 SHEET 1 OF 1 REV A

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)